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(12) **United States Design Patent** (10) **Patent No.:** **US D914,623 S**
Alfredsson et al. (45) **Date of Patent:** **** Mar. 30, 2021**

(54) **ELECTRONIC DEVICE HOUSING**

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(51) **LOC (13) Cl.** **13-03**

(52) **U.S. Cl.**

USPC **D13/184**; D13/110; D13/123

(58) **Field of Classification Search**

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D14/301, 439

CPC G05B 9/02; G05B 19/05; G05B 19/054;

G05B 19/056; G06F 1/182; G06F 1/183;

G06F 1/26; H05K 7/1462; H05K 7/1467;

H05K 7/1474; H05K 7/1432; H02B 1/26;

H02B 1/30; H02B 1/305

See application file for complete search history.

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(57)

CLAIM

The ornamental design for a electronic device housing, as shown and described.

DESCRIPTION

FIG. 1 is a top, front isometric view of a electronic device housing in accordance with a new design;

FIG. 2 is a left side elevational view thereof;

FIG. 3 is a right side elevational view thereof;

FIG. 4 is a front elevational view thereof;

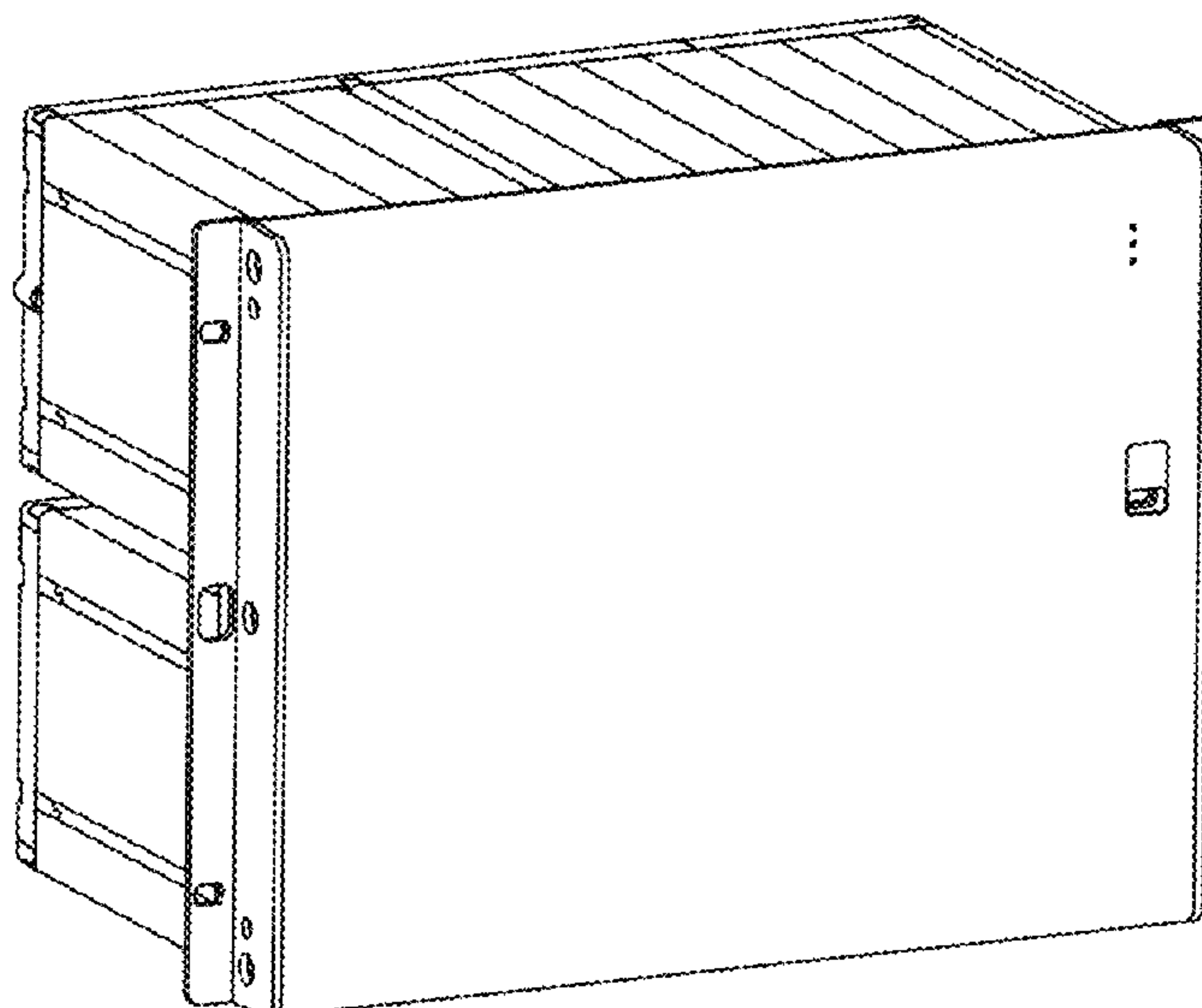
FIG. 5 is a rear elevational view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

The broken line portions of the figure drawings are included to show unclaimed subject matter only and form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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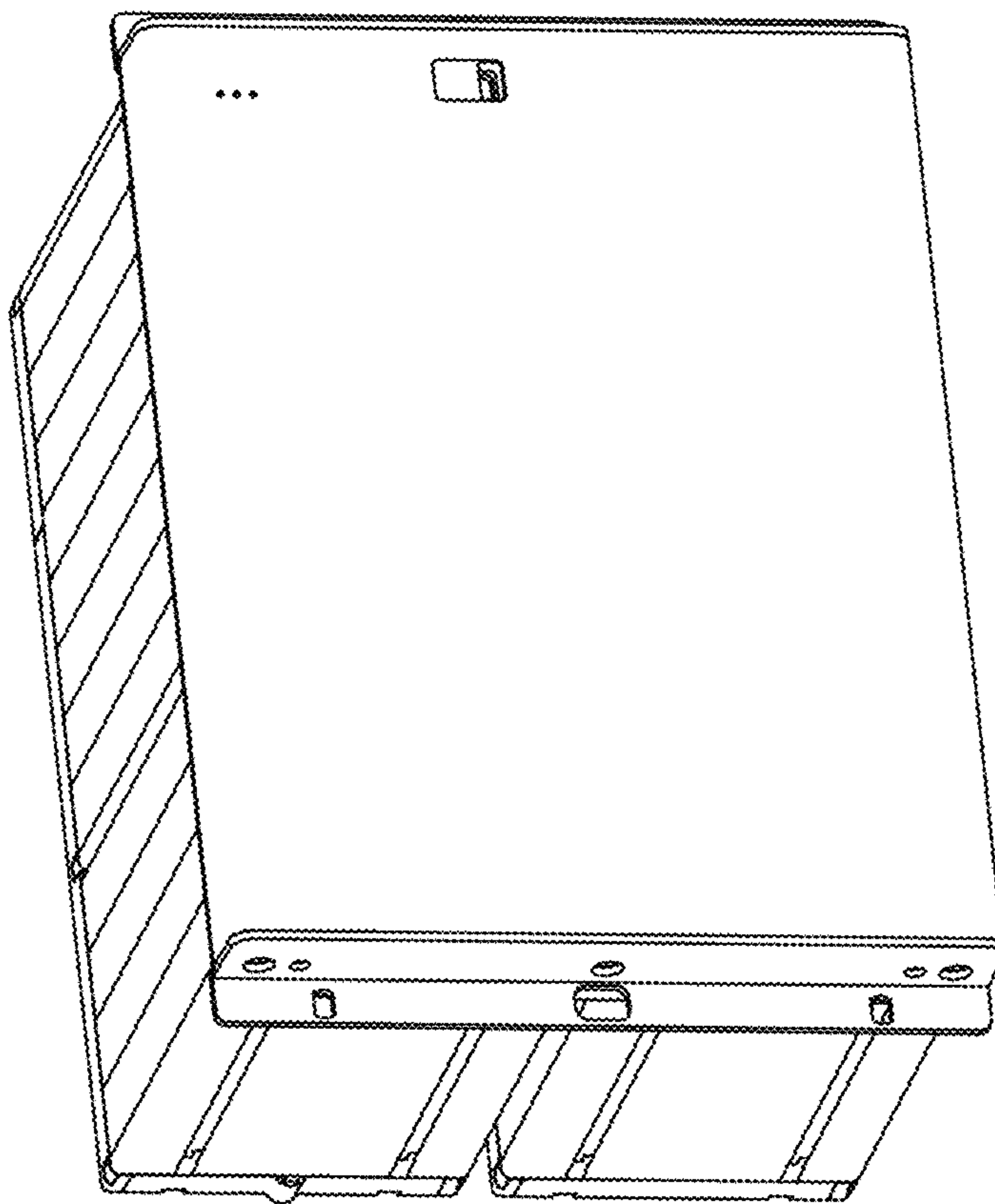


FIG. 1

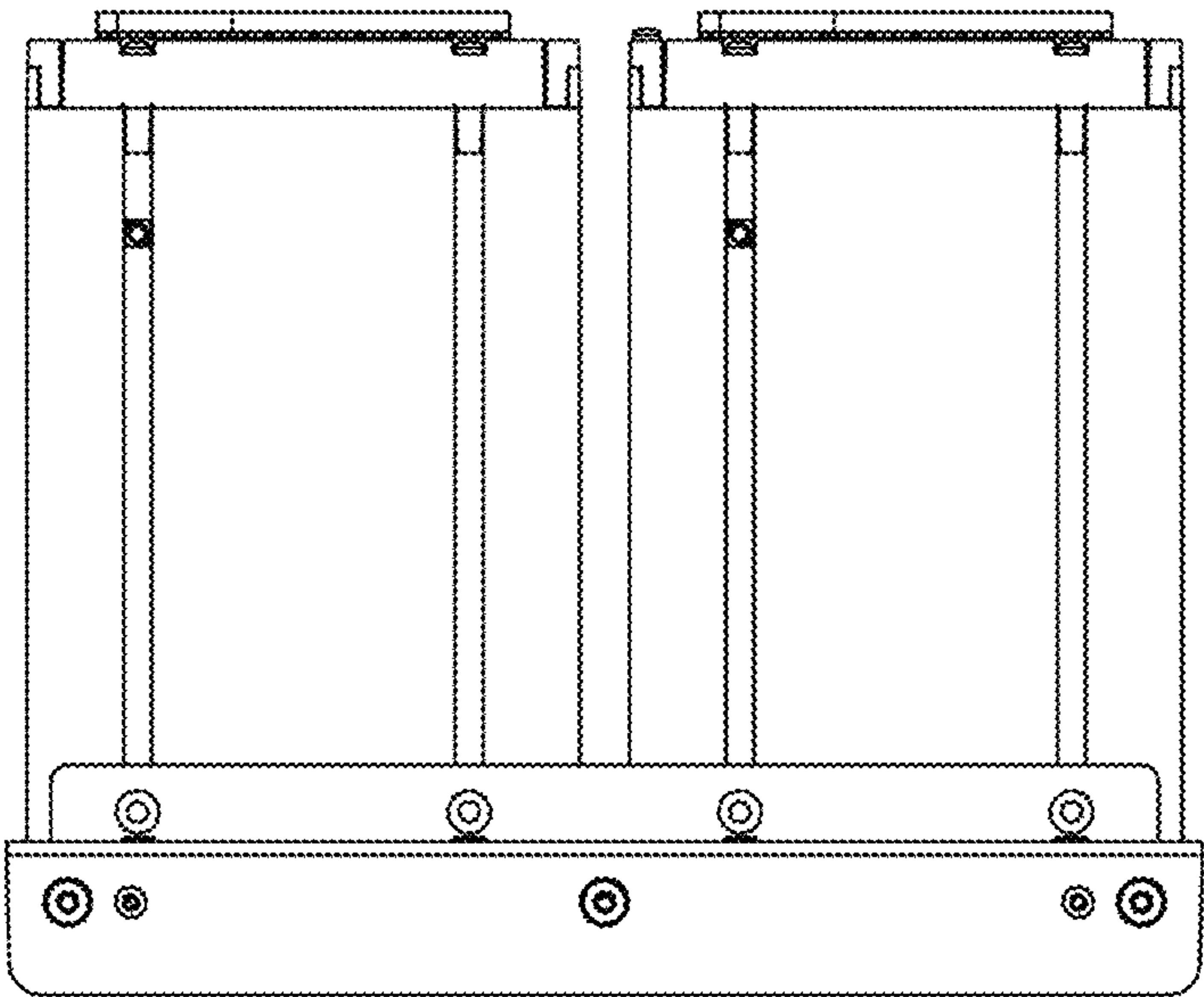


FIG. 2

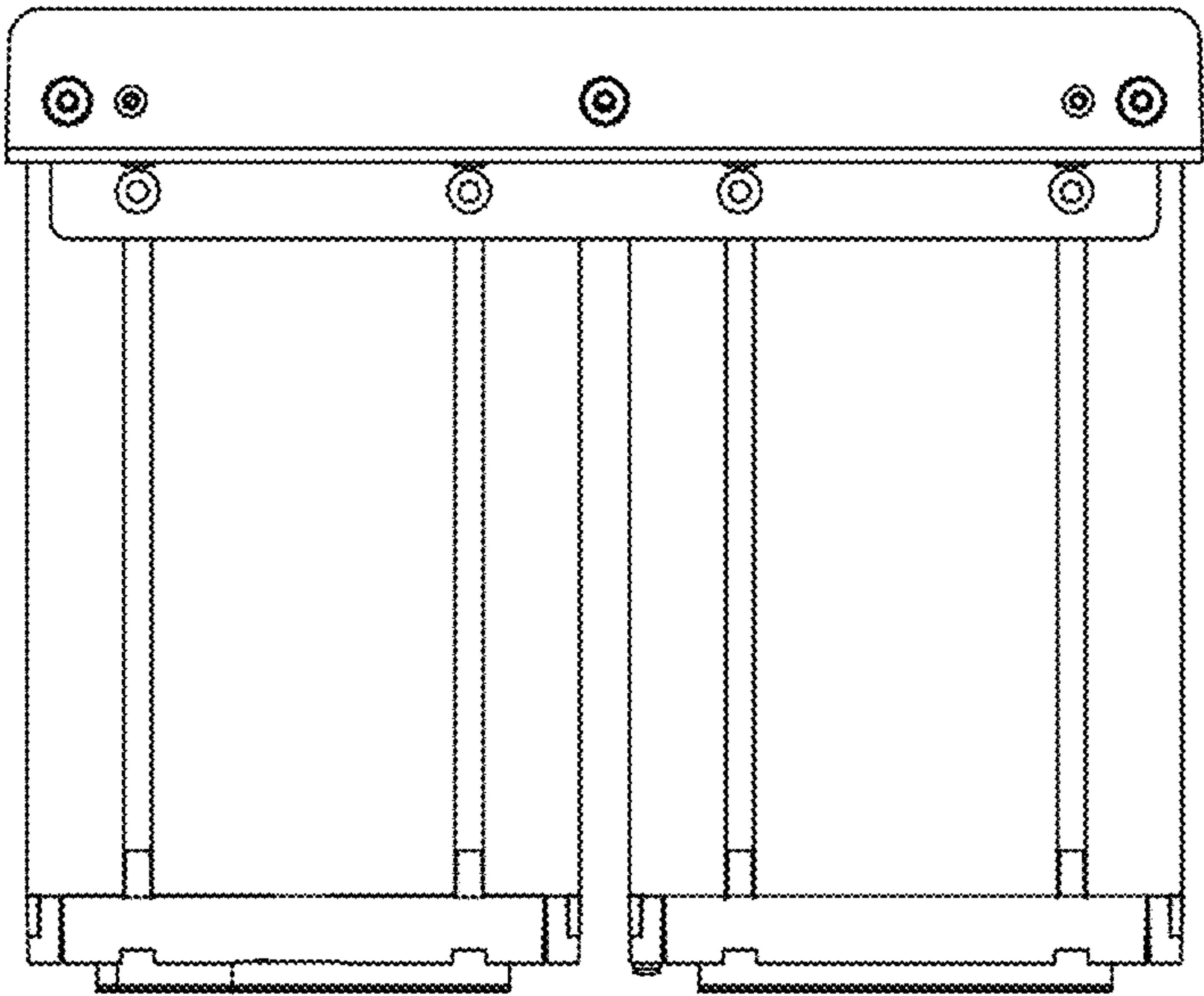


FIG. 3

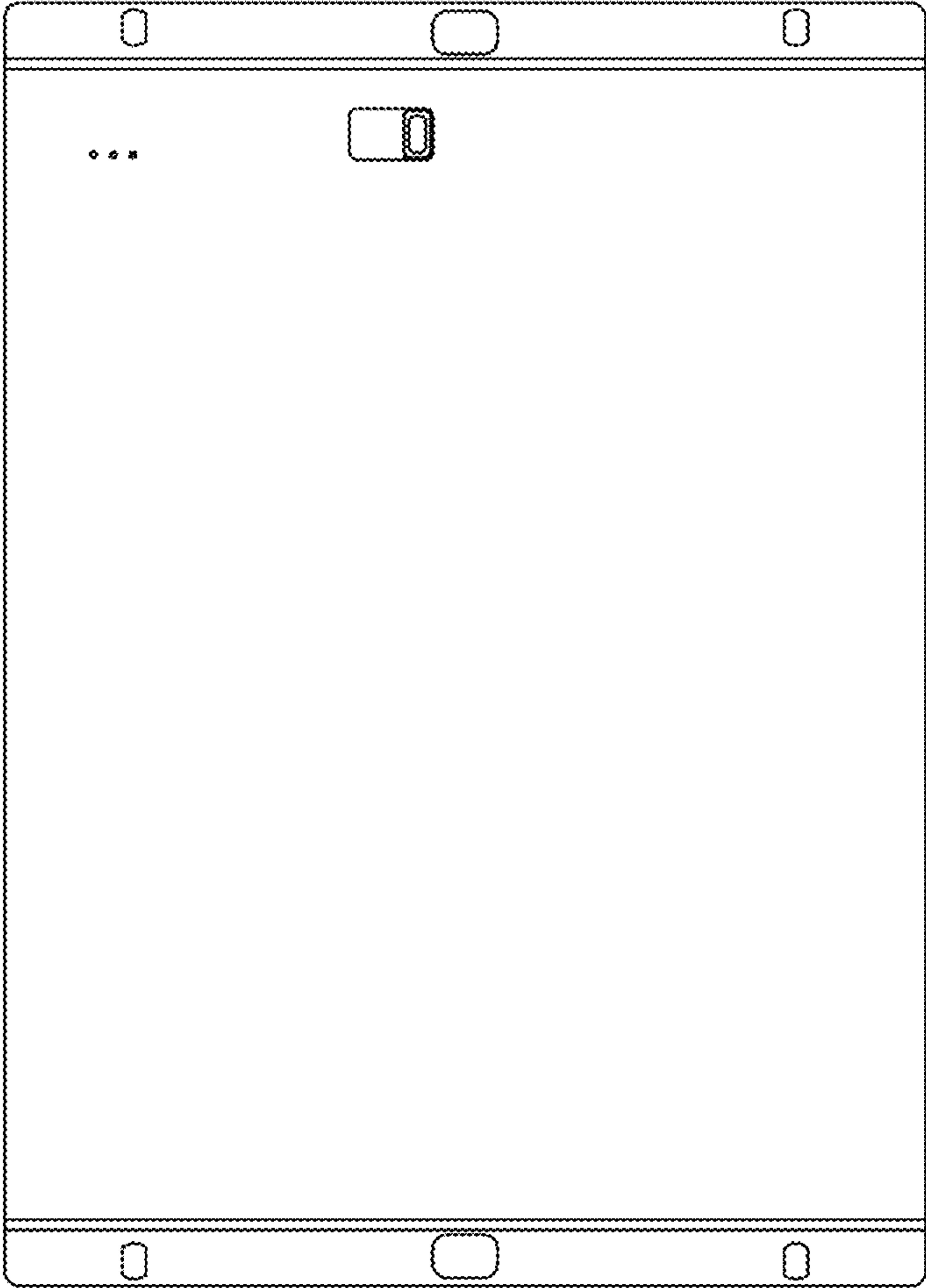


FIG. 4

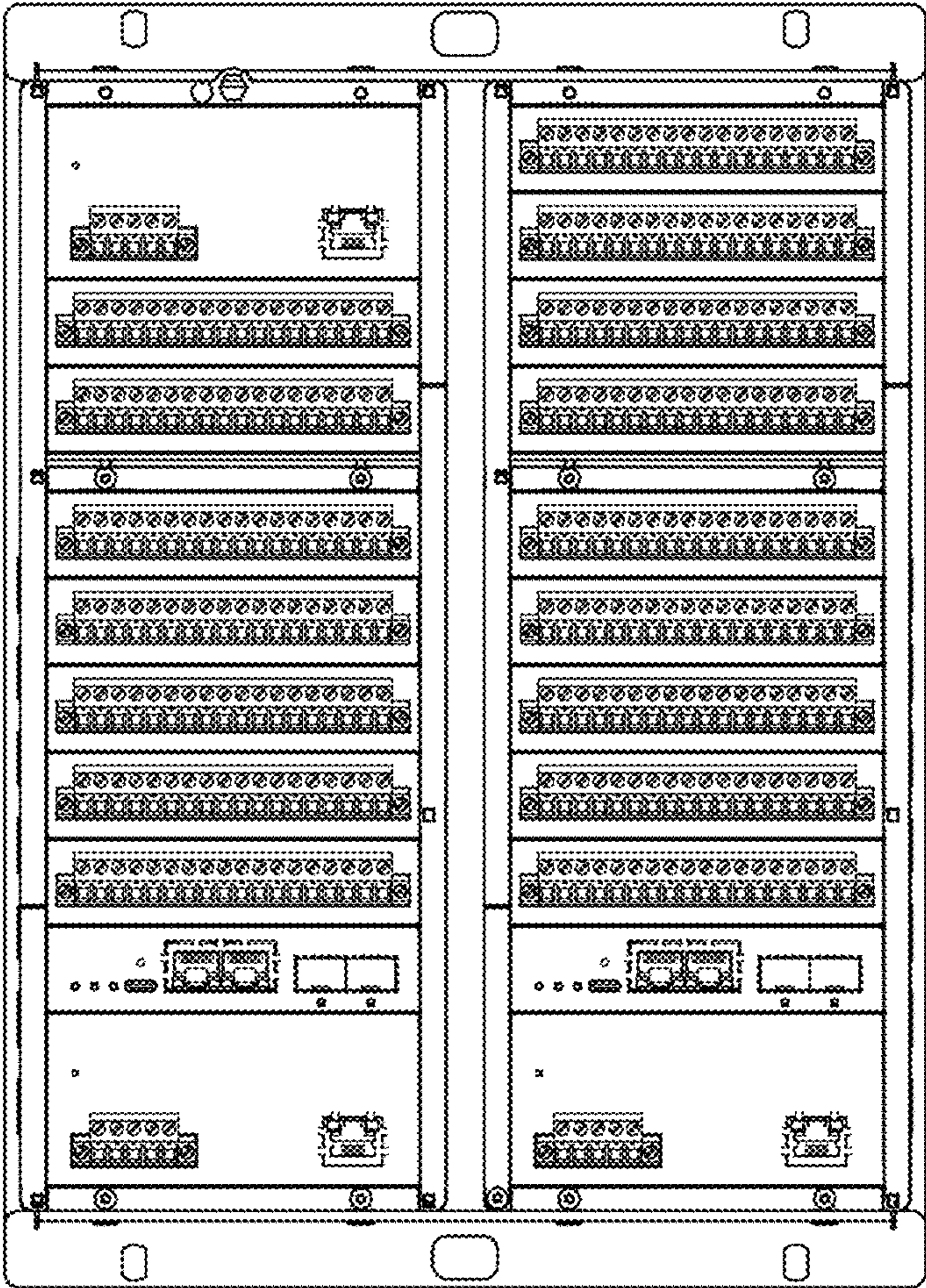


FIG. 5

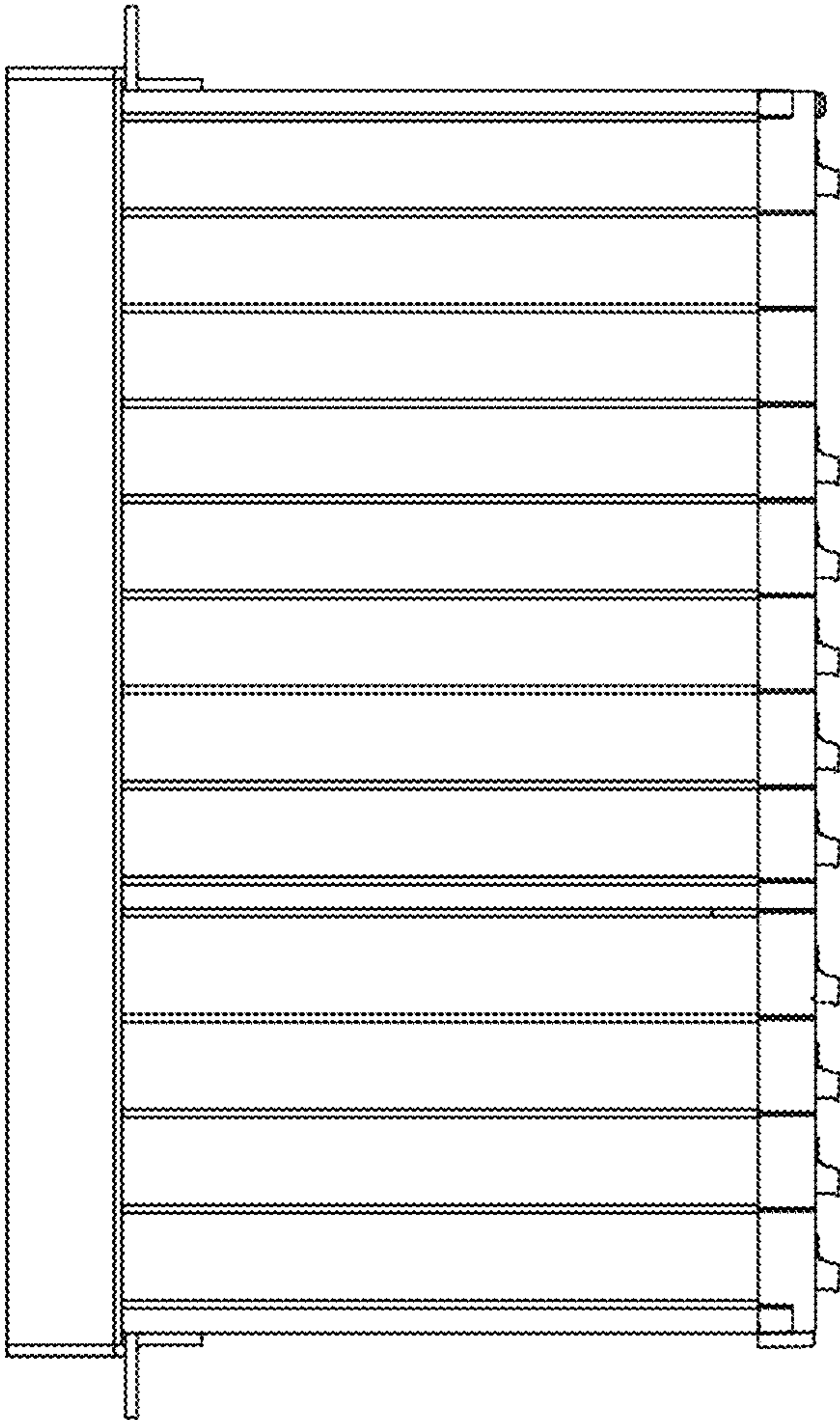


FIG. 6

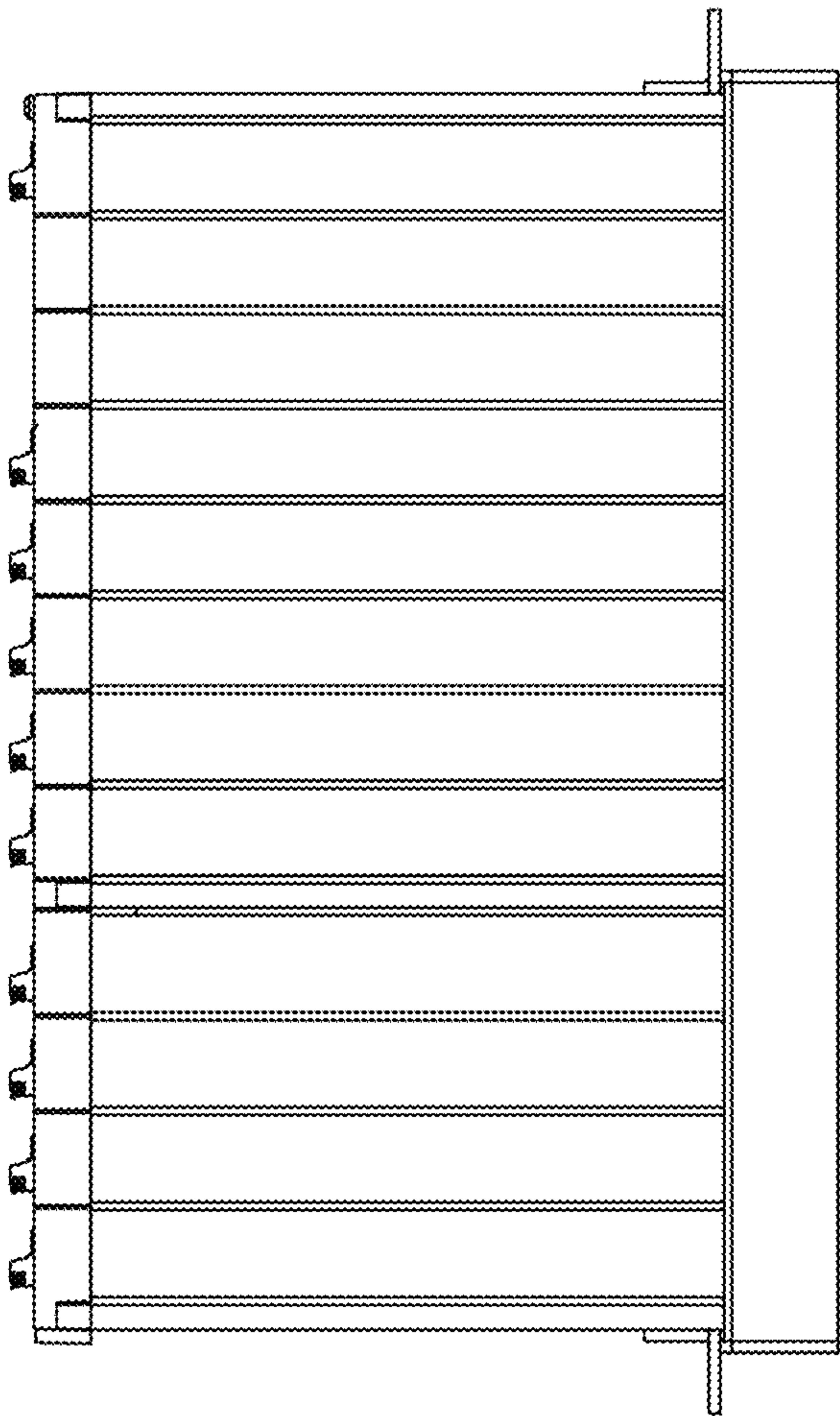


FIG. 7